# **Switching Diode**

#### **Features**

- SOD-123 Surface Mount Package
- High Breakdown Voltage
- Fast Speed Switching Time
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant



### ON Semiconductor®

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SOD-123 CASE 425 PLASTIC

#### **MAXIMUM RATINGS**

| Rating  | Symbol                 | Value      | Unit   |
|---|------------------------|------------|--------|
| Continuous Reverse Voltage  | $V_{R}$                | 100        | Vdc    |
| Peak Forward Current  | Ιϝ                     | 200        | mAdc   |
| Peak Forward Surge Current  | I <sub>FM(surge)</sub> | 500        | mAdc   |
| Non-repetitive Peak Forward Surge Current Pulse Width =1 second Pulse Width =1 micro second | I <sub>FSM</sub>       | 1.0<br>2.0 | A<br>A |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

### THERMAL CHARACTERISTICS

| Characteristic  | Symbol                            | Max            | Unit        |
|---|-----------------------------------|----------------|-------------|
| Total Device Dissipation FR-5 Board (Note 1)  T <sub>A</sub> = 25°C Derate above 25°C | P <sub>D</sub>                    | 425<br>3.4     | mW<br>mW/°C |
| Thermal Resistance,<br>Junction-to-Ambient  | $R_{	heta JA}$                    | 290            | °C/W        |
| Junction and Storage Temperature Range  | T <sub>J</sub> , T <sub>stg</sub> | -55 to<br>+150 | °C          |

1. FR-5 = 1.0oz Cu, 1.0in<sup>z</sup> pad

### **MARKING DIAGRAM**



5D = Specific Device Code

M = Date Code

■ = Pb-Free Package (Note: Microdot may be in either location)

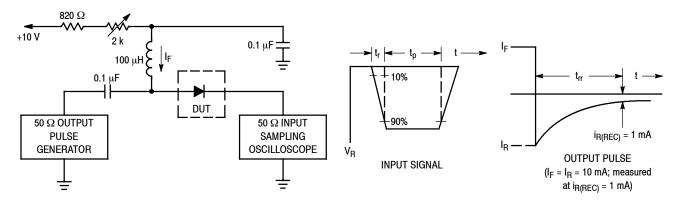
### ORDERING INFORMATION

| Device     | Package              | Shipping <sup>†</sup> |
|------------|----------------------|-----------------------|
| MMSD914T1G | SOD-123<br>(Pb-Free) | 3000 / Tape & Reel    |
| MMSD914T3G | SOD-123<br>(Pb-Free) | 10,000 / Tape & Reel  |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

### **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C unless otherwise noted)

| Characteristic   |                 | Min | Max       | Unit         |
|--|-----------------|-----|-----------|--------------|
| OFF CHARACTERISTICS  |                 |     |           |              |
| Reverse Breakdown Voltage (I <sub>BR</sub> = 100 μAdc)                               | $V_{(BR)}$      | 100 | -         | Vdc          |
| Reverse Voltage Leakage Current $(V_R = 20 \text{ Vdc})$<br>$(V_R = 75 \text{ Vdc})$ | I <sub>R</sub>  | -   | 25<br>5.0 | nAdc<br>μAdc |
| Forward Voltage (I <sub>F</sub> = 10 mAdc)   |                 | -   | 1000      | mVdc         |
| Diode Capacitance (V <sub>R</sub> = 0 Vdc, f = 1.0 MHz)                              | C <sub>D</sub>  | -   | 4.0       | pF           |
| Reverse Recovery Time (I <sub>F</sub> = I <sub>R</sub> = 10 mAdc) (Figure 1)         | t <sub>rr</sub> | -   | 4.0       | ns           |

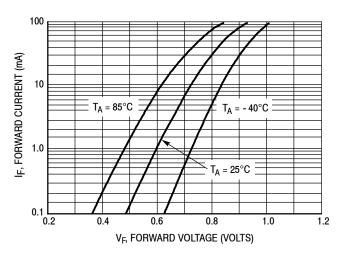


Notes: 1. A 2.0  $k\Omega$  variable resistor adjusted for a Forward Current (IF) of 10 mA.

2. Input pulse is adjusted so  $I_{R(peak)}$  is equal to 10 mA.

3. t<sub>p</sub> » t<sub>rr</sub>

Figure 1. Recovery Time Equivalent Test Circuit



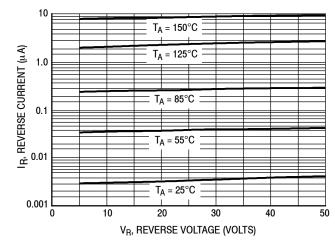


Figure 2. Forward Voltage

Figure 3. Leakage Current

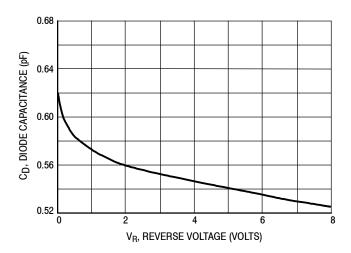
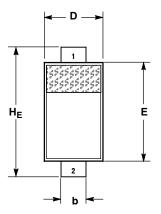
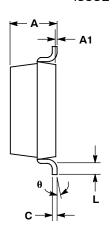


Figure 4. Capacitance

### **ACKAGE DIMENSIONS**

### SOD-123 CASE 425-04 ISSUE G



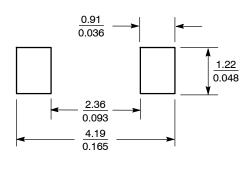


#### NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI
- Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH.

|     | MILLIMETERS |      |      | INCHES |       |       |
|-----|-------------|------|------|--------|-------|-------|
| DIM | MIN         | NOM  | MAX  | MIN    | NOM   | MAX   |
| Α   | 0.94        | 1.17 | 1.35 | 0.037  | 0.046 | 0.053 |
| A1  | 0.00        | 0.05 | 0.10 | 0.000  | 0.002 | 0.004 |
| b   | 0.51        | 0.61 | 0.71 | 0.020  | 0.024 | 0.028 |
| C   |             |      | 0.15 |        |       | 0.006 |
| D   | 1.40        | 1.60 | 1.80 | 0.055  | 0.063 | 0.071 |
| E   | 2.54        | 2.69 | 2.84 | 0.100  | 0.106 | 0.112 |
| HE  | 3.56        | 3.68 | 3.86 | 0.140  | 0.145 | 0.152 |
| L   | 0.25        |      |      | 0.010  |       |       |
| θ   | 0°          |      | 10°  | 0°     |       | 10°   |

### **SOLDERING FOOTPRINT\***



SCALE 10:1  $\left(\frac{\text{mm}}{\text{inches}}\right)$ 

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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